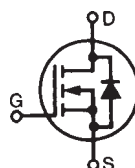


TrenchT2™ GigaMOS™ HiperFET™ Power MOSFET

IXFZ520N075T2

$$\begin{aligned} V_{DSS} &= 75V \\ I_{D25} &= 420A \\ R_{DS(on)} &\leq 1.6m\Omega \end{aligned}$$

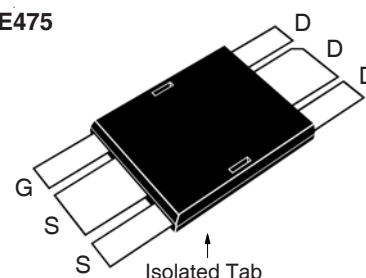
(Electrically Isolated Tab)



N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	$T_J = 25^\circ\text{C}$ to 175°C	75	V
V_{DGR}	$T_J = 25^\circ\text{C}$ to 175°C , $R_{GS} = 1M\Omega$	75	V
V_{GSS}	Continuous	± 20	V
V_{GSM}	Transient	± 30	V
I_{D25}	$T_C = 25^\circ\text{C}$	420	A
I_{DM}	$T_C = 25^\circ\text{C}$, Pulse Width Limited by T_{JM}	1560	A
I_A	$T_C = 25^\circ\text{C}$	200	A
E_{AS}	$T_C = 25^\circ\text{C}$	3	J
P_D	$T_C = 25^\circ\text{C}$	600	W
T_J		-55 ... +175	$^\circ\text{C}$
T_{JM}		175	$^\circ\text{C}$
T_{stg}		-55 ... +175	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS $t = 1$ minute $I_{ISOL} \leq 1\text{mA}$ $t = 1$ second	2500 3000	V~ V~
T_L	1.6mm (0.062 in.) from Case for 10s	300	$^\circ\text{C}$
T_{SOLD}	Plastic Body for 10s	260	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, 1 Minute	2500	V~
F_C	Mounting Force	20..120 / 4.5..27	N/lb.
Weight		3	g

DE475



G = Gate D = Drain
S = Source

Features

- Silicon Chip on Direct-Copper Bond (DCB) Substrate
- Isolated Substrate
 - Excellent Thermal Transfer
 - Increased Temperature and Power Cycling Capability
 - High Isolation Voltage (2500V~)
- 175°C Operating Temperature
- Very High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Very Low $R_{DS(on)}$

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- DC-DC Converters and Off-Line UPS
- Primary-Side Switch
- High Speed Power Switching Applications

Symbol	Test Conditions	Characteristic Values	
	($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Min. Typ. Max.	
BV_{DSS}	$V_{GS} = 0V$, $I_D = 3\text{mA}$	75	V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 8\text{mA}$	2.0	V
I_{GSS}	$V_{GS} = \pm 20V$, $V_{DS} = 0V$		± 200 nA
I_{DSS}	$V_{DS} = V_{DSS}$, $V_{GS} = 0V$ $T_J = 150^\circ\text{C}$		10 μA 1.5 mA
$R_{DS(on)}$	$V_{GS} = 10V$, $I_D = 100A$, Note 1		1.6 m Ω

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	$V_{DS} = 10\text{V}$, $I_D = 60\text{A}$, Note 1	95	160	S
C_{iss}	$V_{GS} = 0\text{V}$, $V_{DS} = 25\text{V}$, $f = 1\text{MHz}$		41	nF
C_{oss}			4150	pF
C_{rss}			530	pF
R_{GI}	Gate Input Resistance		1.36	Ω
$t_{d(on)}$	Resistive Switching Times $V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 200\text{A}$ $R_G = 1\Omega$ (External)		48	ns
t_r			36	ns
$t_{d(off)}$			80	ns
t_f			35	ns
$Q_{g(on)}$	$V_{GS} = 10\text{V}$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_D = 260\text{A}$		545	nC
Q_{gs}			177	nC
Q_{gd}			135	nC
R_{thJC}				0.25 $^\circ\text{C/W}$
R_{thCS}			0.15	$^\circ\text{C/W}$

Source-Drain Diode

Symbol	Test Conditions ($T_J = 25^\circ\text{C}$, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I_S	$V_{GS} = 0\text{V}$			520 A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}			1600 A
V_{SD}	$I_F = 100\text{A}$, $V_{GS} = 0\text{V}$, Note 1			1.25 V
t_{rr}	$I_F = 150\text{A}$, $V_{GS} = 0\text{V}$ $-di/dt = 100\text{A}/\mu\text{s}$ $V_R = 37.5\text{V}$			150 ns
I_{RM}			7	A
Q_{RM}			357	nC

Note 1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592	4,931,844	5,049,961	5,237,481	6,162,665	6,404,065 B1	6,683,344	6,727,585	7,005,734 B2	7,157,338B2
4,860,072	5,017,508	5,063,307	5,381,025	6,259,123 B1	6,534,343	6,710,405 B2	6,759,692	7,063,975 B2	
4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	7,071,537	

Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

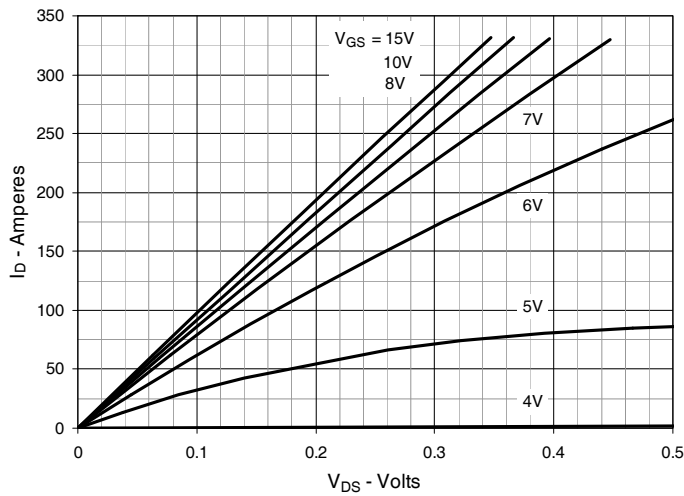


Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

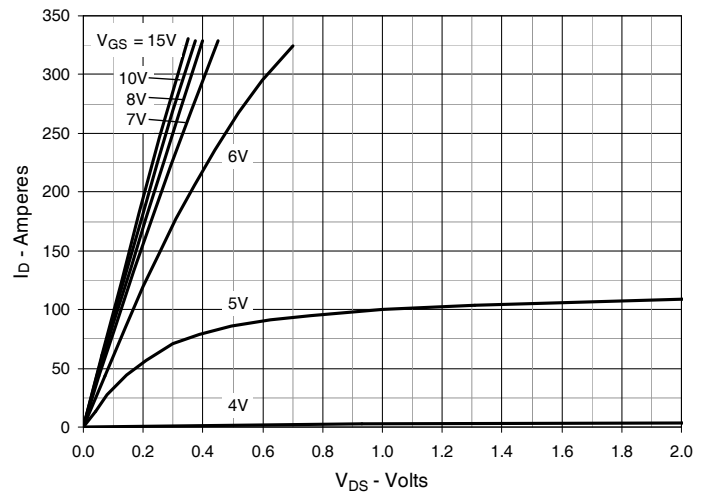


Fig. 3. Output Characteristics @ $T_J = 150^\circ\text{C}$

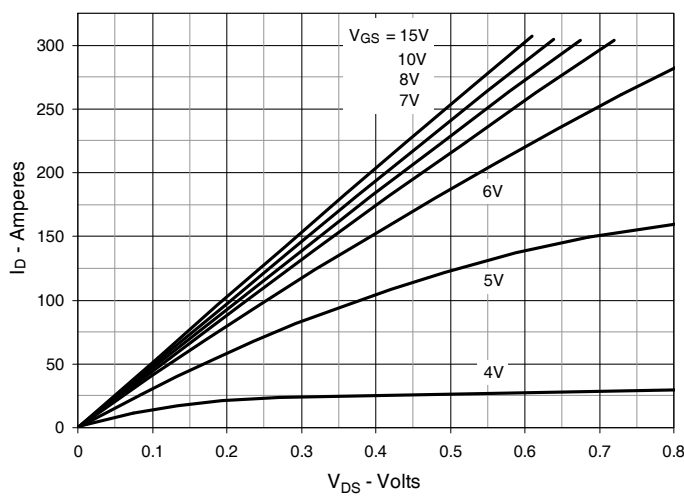


Fig. 4. Normalized $R_{DS(on)}$ vs. Junction Temperature

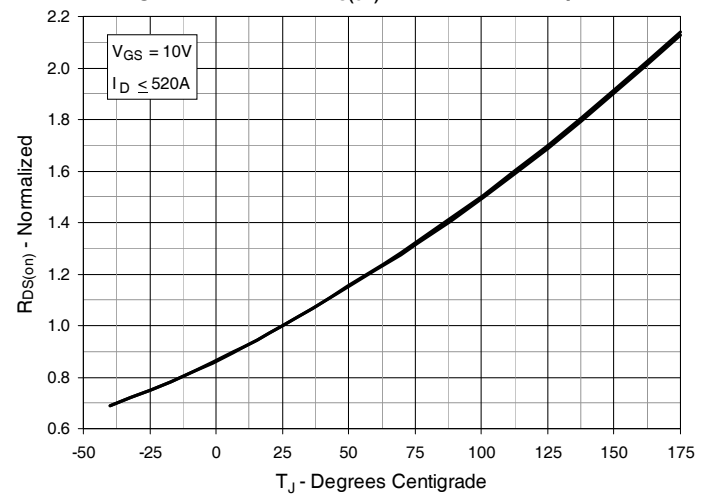


Fig. 5. Normalized $R_{DS(on)}$ vs. Drain Current

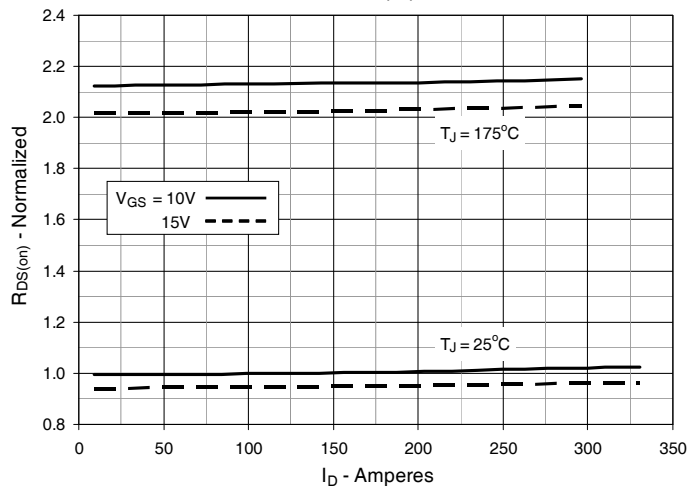


Fig. 6. Drain Current vs. Case Temperature

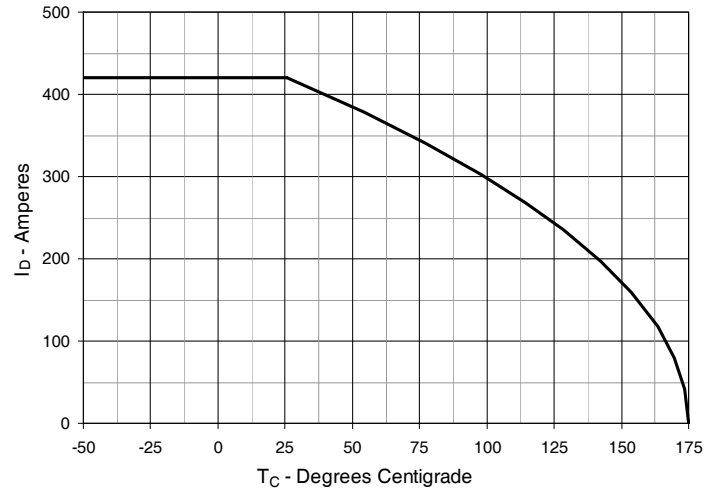


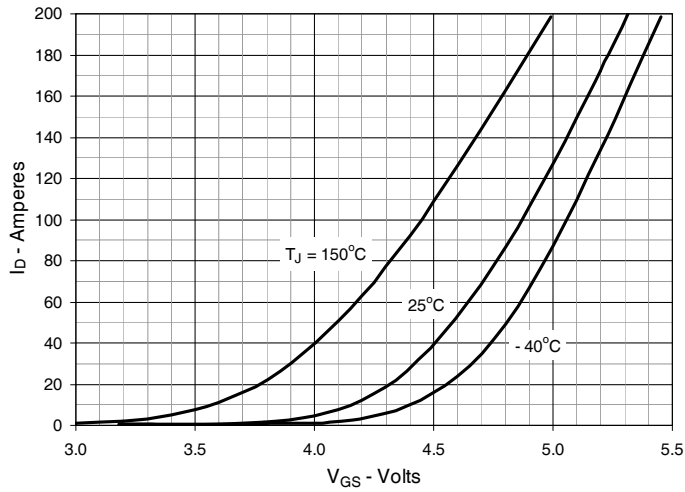
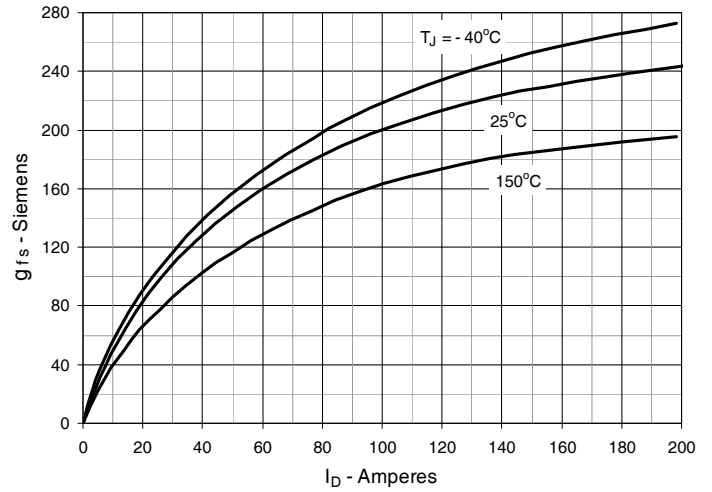
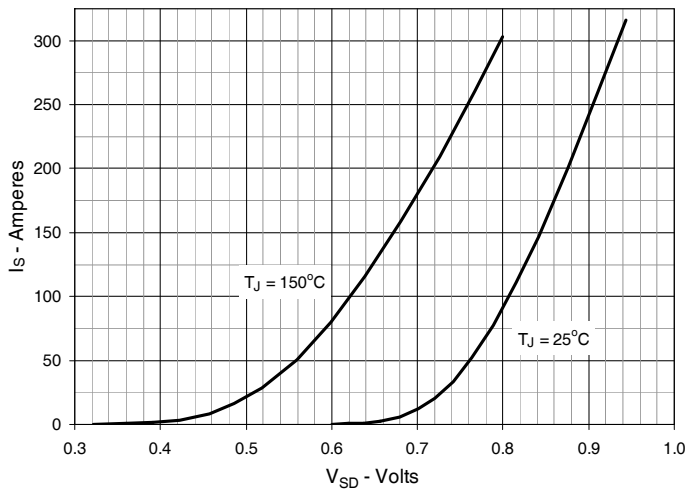
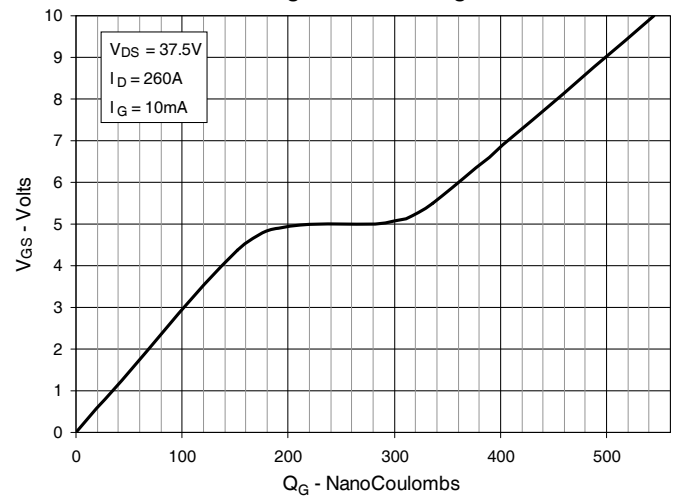
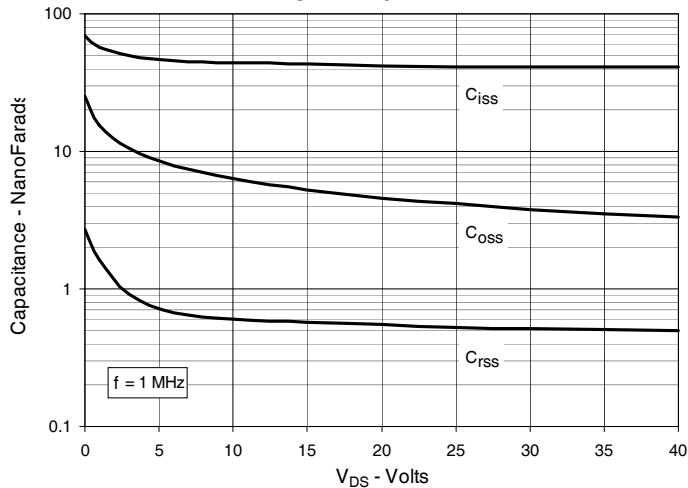
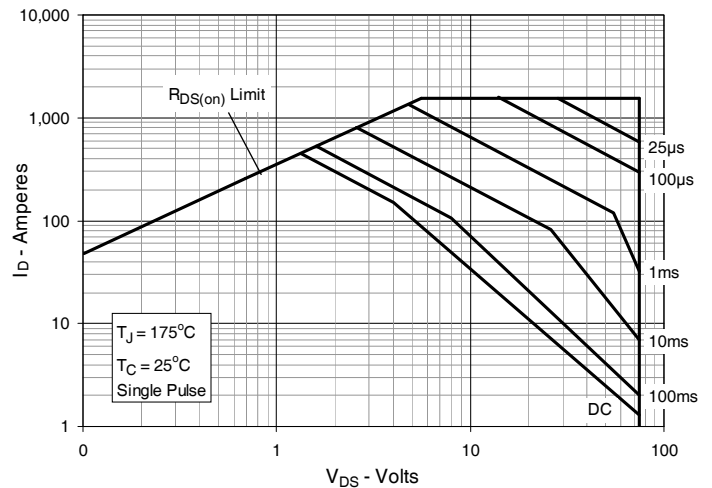
Fig. 7. Input Admittance

Fig. 8. Transconductance

Fig. 9. Forward Voltage Drop of Intrinsic Diode

Fig. 10. Gate Charge

Fig. 11. Capacitance

Fig. 12. Forward-Bias Safe Operating Area


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

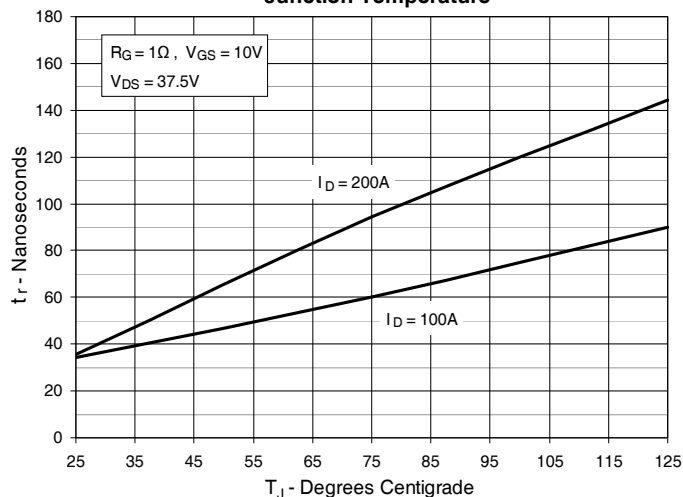


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

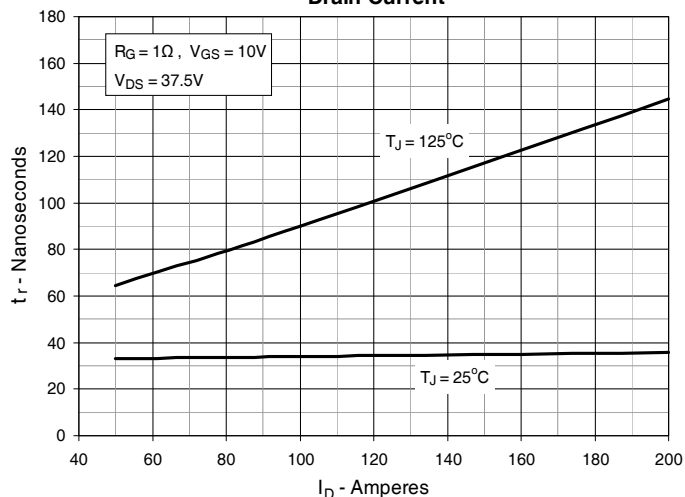


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

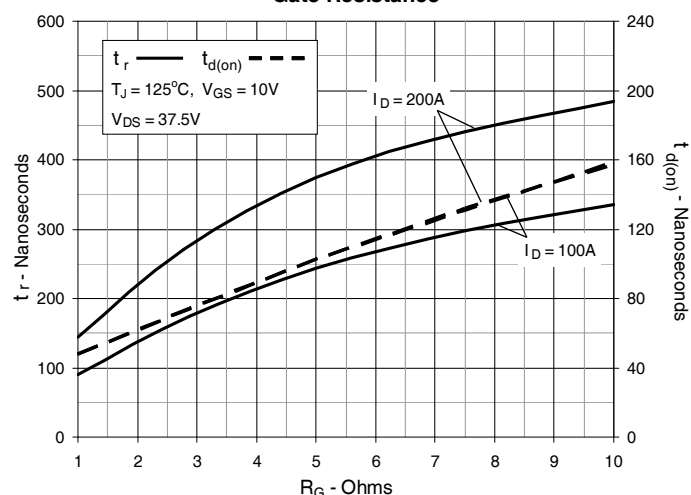


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

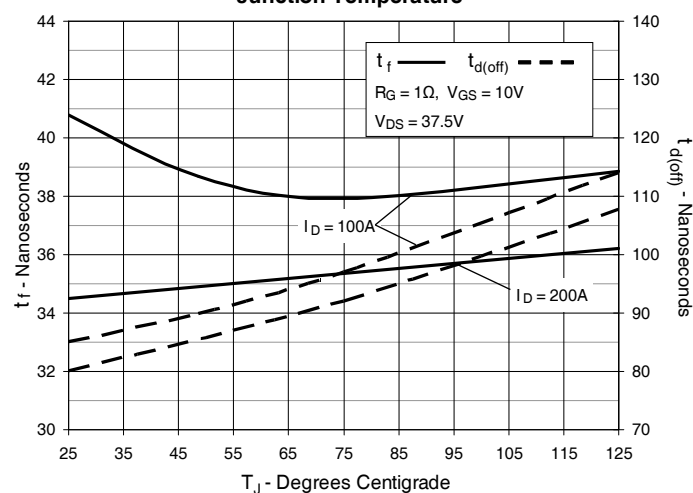


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

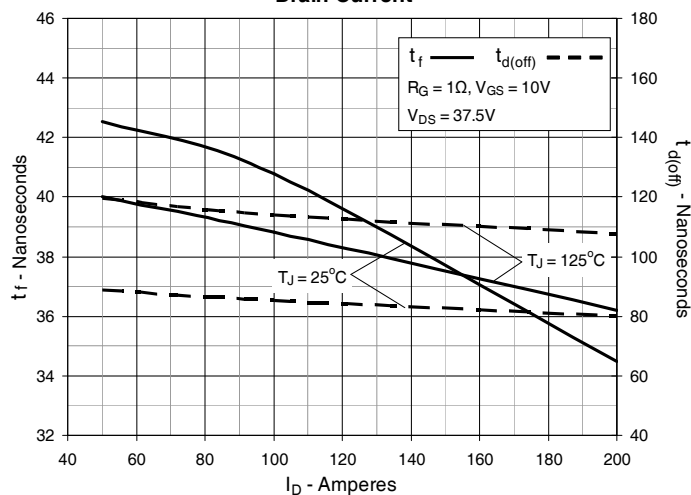
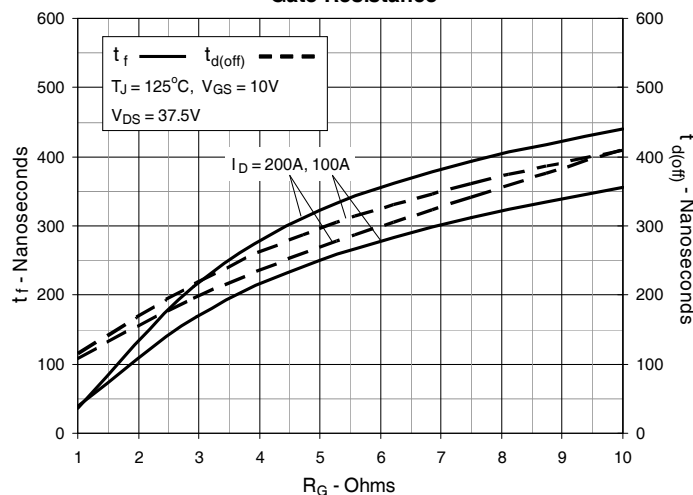


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance



The graph shows the relationship between the normalized junction temperature $Z_{(th)JC} - K / W$ and the pulse width in seconds. The y-axis is logarithmic, with major ticks at 0.001, 0.010, 0.100, and 0.400. The x-axis is also logarithmic, with major ticks at 0.00001, 0.0001, 0.001, 0.01, 0.1, 1, and 10. The curve starts at a value of approximately 0.002 for a pulse width of 0.00001 seconds and increases steadily, reaching a plateau of about 0.35 for pulse widths greater than 1 second.

Pulse Width - Seconds	$Z_{(th)JC} - K / W$
0.00001	0.002
0.0001	0.006
0.001	0.020
0.01	0.060
0.1	0.200
1	0.320
10	0.350

Technical drawing of a shaft-hub assembly. The drawing includes a side view of the shaft and a cross-sectional view of the hub assembly.

Shaft Dimensions (Side View):

- Total length: 1.600 [40.64]
- Left end diameter: 0.162 [4.11]
- Right end diameter: 0.162 [4.11]
- Central section diameter: 0.125 [3.18]
- Central section length: 0.770 [19.56]
- Central section fillet radius: R0.050 [1.27]

Hub Assembly Dimensions (Cross-sectional View):

- Hub material: Steel (S)
- Shaft material: Steel (S)
- Hub diameter: 0.306 [7.77]
- Shaft diameter: 0.162 [4.11]
- Hub length: 0.070 [1.78]
- Shaft length: 0.050 [1.27]
- Hub fillet radius: R0.0346 [8.79]
- Shaft fillet radius: R0.006 [0.15]
- Shaft end diameter: 0.049 [1.24]

LEADS – Full Silver plating.



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